Preferred Device

Triacs

Silicon Bidirectional Thyristors

Designed primarily for full-wave ac control applications, such as solid-state relays, motor controls, heating controls and power supplies; or wherever full-wave silicon gate controlled solid-state devices are needed. Triac type thyristors switch from a blocking to a conducting state for either polarity of applied main terminal voltage with positive or negative gate triggering.

- Blocking Voltage to 800 Volts
- All Diffused and Glass Passivated Junctions for Greater Parameter Uniformity and Stability
- Small, Rugged, Thermowatt Construction for Low Thermal Resistance, High Heat Dissipation and Durability
- Gate Triggering Guaranteed in Four Modes
- **%** Indicates UL Registered File #E69369
- Device Marking: Logo, Device Type, e.g., MAC15A6FP, Date Code

MAXIMUM RATINGS (T_{.1} = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off–State Voltage(1) (T _J = -40 to +125°C, Sine Wave 50 to 60 Hz, Gate Open) MAC15A6FP MAC15A8FP MAC15A10FP	V _{DRM} , VRRM	400 600 800	Volts
On-State RMS Current ($T_C = +80^{\circ}C$)(2) Full Cycle Sine Wave 50 to 60 Hz ($T_C = +95^{\circ}C$)	lT(RMS)	15 12	Amps
Peak Nonrepetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, T _C = +80°C) Preceded and followed by rated current	ITSM	150	Amps
Circuit Fusing (t = 8.3 ms)	I ² t	93	A ² s
Peak Gate Power (T _C = +80°C, Pulse Width = 2.0 μs)	Рдм	20	Watts
Average Gate Power (T _C = +80°C, t = 8.3 ms)	P _G (AV)	0.5	Watt
Peak Gate Current (Pulse Width $\leq 1.0 \mu sec; T_C = 80^{\circ}C$)	I _{GM}	2.0	Amps
Peak Gate Voltage (Pulse Width $\leq 1.0 \mu sec; T_C = 80^{\circ}C)$	VGМ	10	Volts
RMS Isolation Voltage (T _A = 25°C, Relative Humidity ≤ 20%) (%)	V _(ISO)	1500	Volts
Operating Junction Temperature	TJ	-40 to +125	°C
Storage Temperature Range	T _{stg}	–40 to +150	°C

- (1) VDRM and VRRM for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.
- (2) The case temperature reference point for all T_C measurements is a point on the center lead of the package as close as possible to the plastic body.



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ISOLATED TRIAC (94) 15 AMPERES RMS 400 thru 800 VOLTS





ISOLATED TO-220 Full Pack CASE 221C STYLE 3

PIN ASSIGNMENT		
1	Main Terminal 1	
2	Main Terminal 2	
3	Gate	

ORDERING INFORMATION

Device	Package	Shipping
MAC15A6FP	ISOLATED TO220FP	500/Box
MAC15A8FP	ISOLATED TO220FP	500/Box
MAC15A10FP	ISOLATED TO220FP	500/Box

Preferred devices are recommended choices for future use and best overall value.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{ heta JC}$	2.0	°C/W
Thermal Resistance, Case to Sink	$R_{\theta}CS$	2.2 (typ)	°C/W
Thermal Resistance, Junction to Ambient	$R_{ heta JA}$	60	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	TL	260	°C

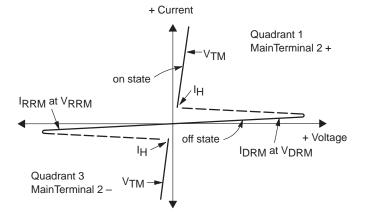
$\textbf{ELECTRICAL CHARACTERISTICS} \ (T_C = 25^{\circ}\text{C unless otherwise noted}; \ \text{Electricals apply in both directions})$

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
$ \begin{array}{ll} \mbox{Peak Repetitive Blocking Current} & T_{\mbox{\scriptsize J}} = 25^{\circ}\mbox{\scriptsize C} \\ \mbox{\scriptsize (V_D = Rated V_{\mbox{\scriptsize DRM}}, V_{\mbox{\scriptsize RRM}}; Gate Open)} & T_{\mbox{\scriptsize J}} = 125^{\circ}\mbox{\scriptsize C} \\ \end{array} $	I _{DRM} , I _{RRM}	_	=	10 2.0	μA mA
ON CHARACTERISTICS					
Peak On-State Voltage(1) (I _{TM} = ±21 A Peak	V _{TM}	-	1.3	1.6	Volts
Gate Trigger Current (Continuous dc) (Main Terminal Voltage = 12 Vdc, R _L = 100 Ohms) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-) MT2(-), G(+)	^I GT	_ _ _	_ _ _ _	50 50 50 75	mA
Gate Trigger Voltage (Continuous dc) (Main Terminal Voltage = 12 Vdc, R _L = 100 Ohms) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-) MT2(-), G(+)	VGT	_ _ _ _	0.9 0.9 1.1 1.4	2.0 2.0 2.0 2.5	Volts
Gate Non–Trigger Voltage (Main Terminal Voltage = Rated V_{DRM} , R_L = 100 Ω , T_J = +110°C) All 4 Quadrants	V _{GD}	0.2	_	_	Volts
Holding Current (Main Terminal Voltage = 12 Vdc, Gate Open, Initiating Current = ±200 mA)	lн	_	6.0	40	mA
Turn-On Time (V_D = Rated V_{DRM} , I_{TM} = 17 A, I_{GT} = 120 mA, Rise Time = 0.1 μ s, Pulse Width = 2 μ s)	^t gt		1.5	_	μѕ
DYNAMIC CHARACTERISTICS					
Critical Rate of Rise of Commutation Voltage (V_D = Rated V_{DRM} , V_{RRM} , I_{TM} = 21 A, Commutating di/dt = 7.6 A/ms, Gate Unenergized, T_C = 80°C)	dv/dt(c)	_	5.0	_	V/µs

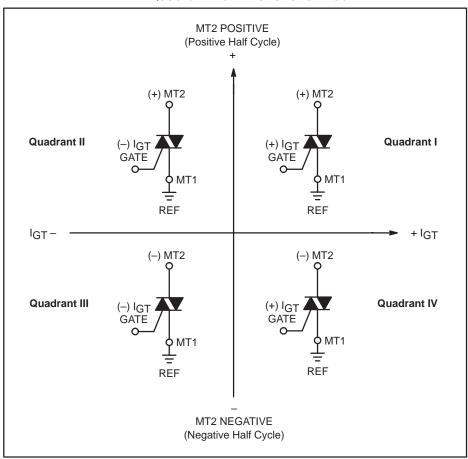
⁽¹⁾ Pulse Test: Pulse Width \leq 2.0 ms, Duty Cycle \leq 2%.

Voltage Current Characteristic of Triacs (Bidirectional Device)

Symbol	Parameter
VDRM	Peak Repetitive Forward Off State Voltage
IDRM	Peak Forward Blocking Current
VRRM	Peak Repetitive Reverse Off State Voltage
IRRM	Peak Reverse Blocking Current
V_{TM}	Maximum On State Voltage
lΗ	Holding Current



Quadrant Definitions for a Triac



All polarities are referenced to MT1.

With in-phase signals (using standard AC lines) quadrants I and III are used.

TYPICAL CHARACTERISTICS

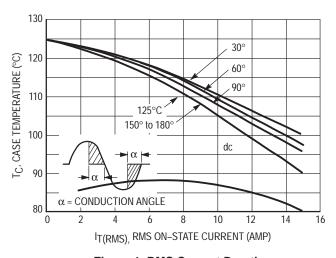


Figure 1. RMS Current Derating

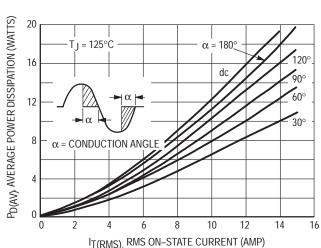


Figure 2. On-State Power Dissipation

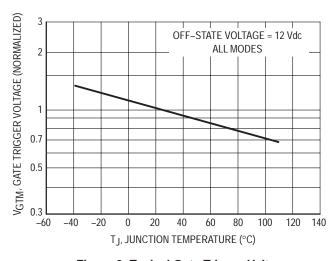


Figure 3. Typical Gate Trigger Voltage

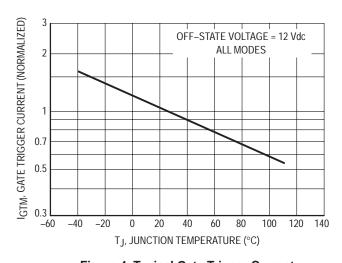


Figure 4. Typical Gate Trigger Current

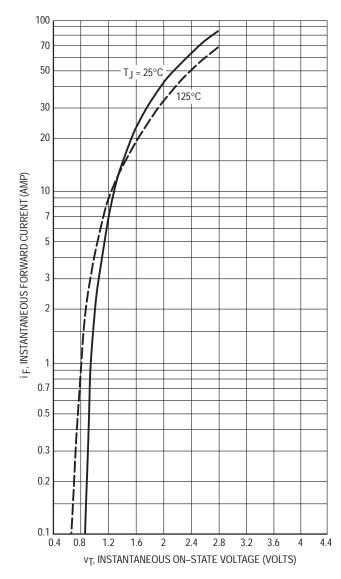
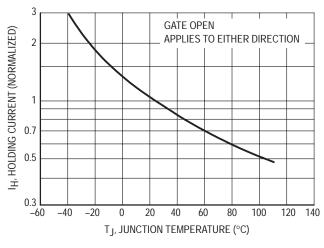


Figure 5. Maximum On-State Characteristics



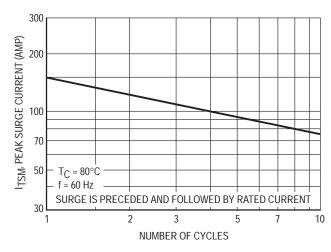


Figure 6. Typical Holding Current

Figure 7. Maximum Nonrepetitive Surge Current

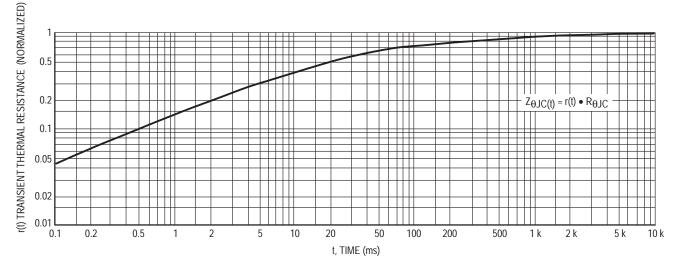
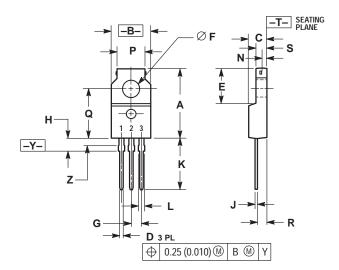


Figure 8. Thermal Response

PACKAGE DIMENSIONS

ISOLATED TO-220 Full Pack

CASE 221C-02 ISSUE C



- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: INCH.

 3. LEAD DIMENSIONS UNCONTROLLED WITHIN DIMENSION Z.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.680	0.700	17.28	17.78
В	0.388	0.408	9.86	10.36
С	0.175	0.195	4.45	4.95
D	0.025	0.040	0.64	1.01
Ε	0.340	0.355	8.64	9.01
F	0.140	0.150	3.56	3.81
G	0.100 BSC		2.54 BSC	
Н	0.110	0.155	2.80	3.93
J	0.018	0.028	0.46	0.71
K	0.500	0.550	12.70	13.97
L	0.045	0.070	1.15	1.77
N	0.049		1.25	
Р	0.270	0.290	6.86	7.36
Q	0.480	0.500	12.20	12.70
R	0.090	0.120	2.29	3.04
S	0.105	0.115	2.67	2.92
Z	0.070	0.090	1.78	2.28

STYLE 3: PIN 1. MT 1



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